

The High-energy Electron Xtallography Instrument

A tool for macromolecular structure determination: update

CCP4 Workshop

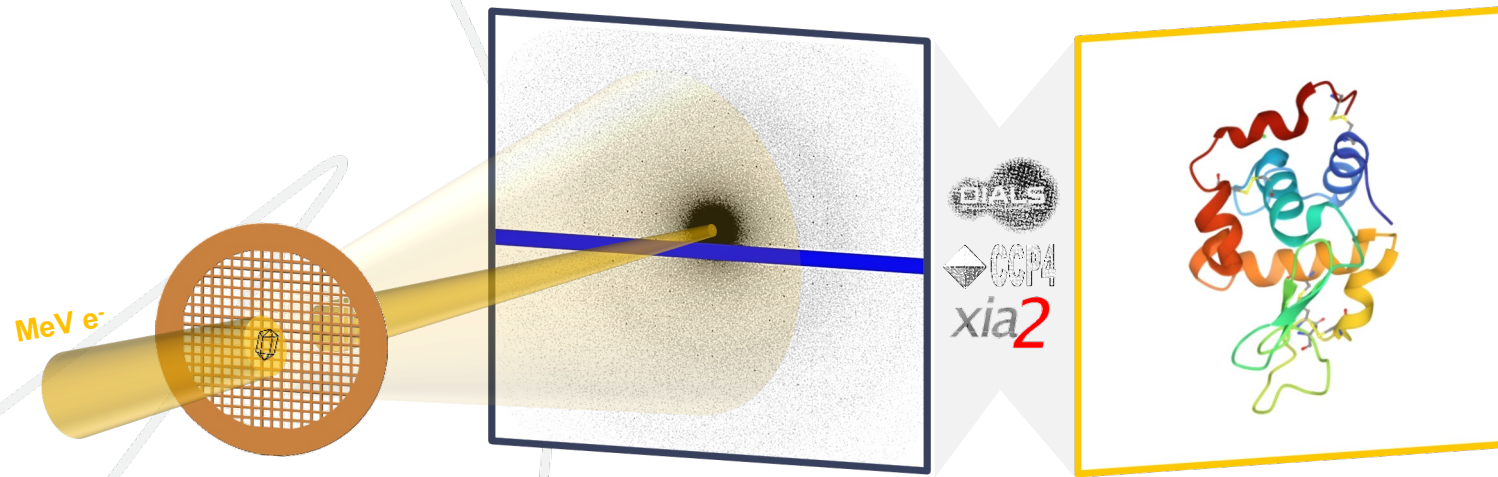
5th December 2023

Alistair Siebert



Introduction to HeXI

The **H**igh-energy **E**lectron **X**tallography **I**nstrument (**HeXI**) project aims to investigate the use of mega electron volt (MeV) electrons in macromolecular structure determination by 3DED



- Funded by The Wellcome “Electrifying Life Science” grant and MX@Diamond Light Source
- Combine the sensitivity of electrons with the performance of MX-grade goniometry

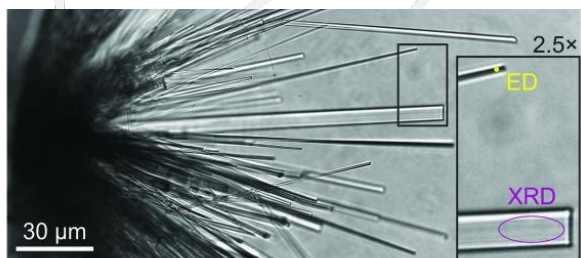
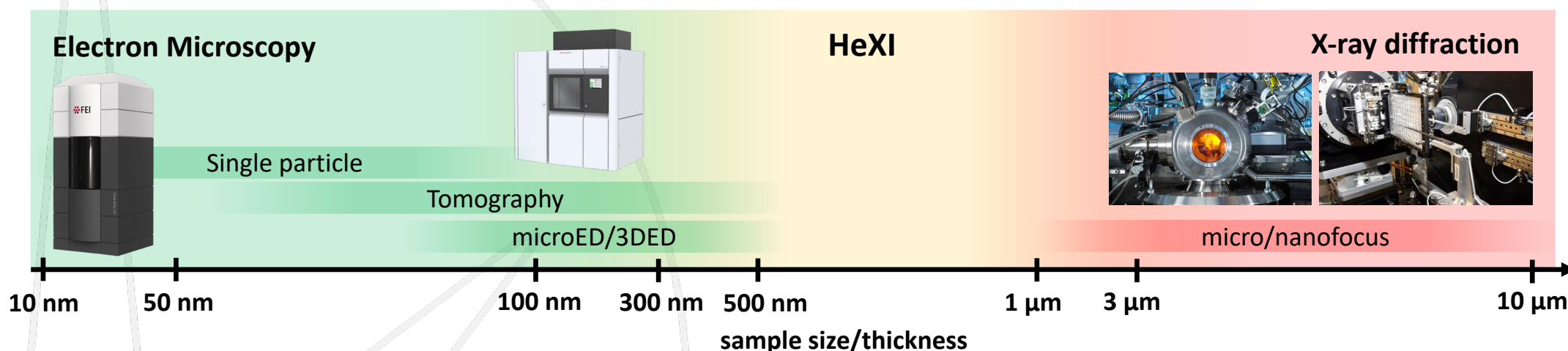
New Grant will Electrify Life Sciences
with Breakthrough Technologies

HeXI
Electrifying Life Science



HeXI instrument target and scope

The preferred structure determination technique varies as a function of sample size/thickness:



A. Lanza et al., IUCrJ (2019). 6, 178–188

HeXI targets 300 nm to 1 µm crystals:

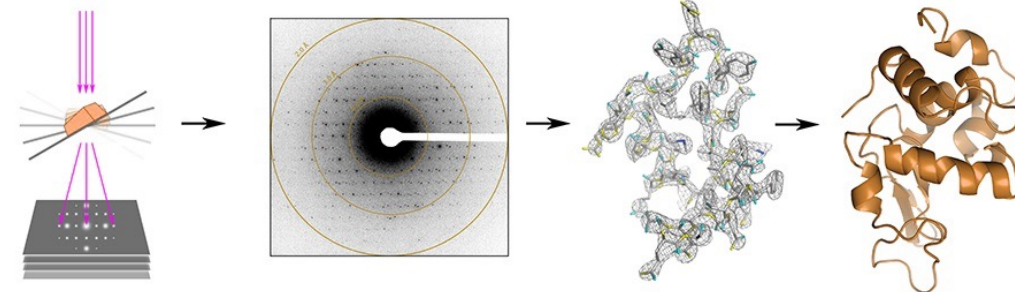
- Discarded crystal slurries from MX → Large number of potential samples
- Good size for ligand soaking studies → Dynamics
- Small molecules → Industry

HeXI will bridge the size gap between electron diffraction on TEMs and X-ray diffraction on MX beamlines

HeXI instrument goals

1. Structure determination from 0.3 to 1 μm crystals

- Use the increased penetration of MeV electrons to bridge the crystal size gap between electrons and X-rays



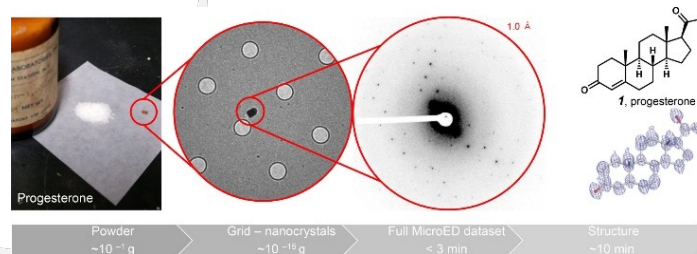
2. Improved fidelity of 3DED data

- Use high performance MX-grade goniometry developed at Diamond
- Reduced dynamic scattering

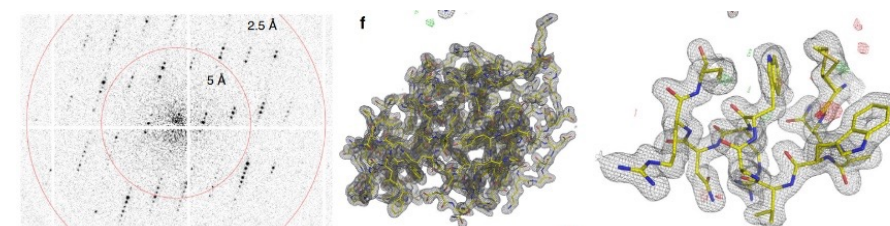


3. A tool for rapid high-resolution structure determination

- 3DED \rightarrow Small molecules
- Cryo-3DED \rightarrow " " + proteins
- SerialED \rightarrow " " + Dynamics



C. G. Jones et al. *ACS Cent. Sci.* 2018, 4, 11, 1587–1592



R. Buckner et al. *Nature Communications*, 11, 996 (2020)

HeXI instrument specifications

Design considerations

- Diffraction optimised instrument
- Low-resolution STEM imaging
- 1 Å resolution (<200 Å unit cells)
- No post-specimen lenses
- Cryo-capabilities
- Samples mounted on TEM grids

| Parameter | Value |
|-------------------------------------|------------|
| Electron beam energy (MeV) | 0.1 – 1 |
| Electron beam timing | CW |
| Energy spread ($\Delta E/E$ FWHM) | $<10^{-4}$ |
| Beam current at source (μA) | 15 |
| Beam current at sample (pA) | 0.6 - 400 |
| Beam size at the sample (μm) | 0.3 - 3 |
| Rotation speed (deg/s) | 60 |
| Environment temperature (K) | 77 and 293 |
| Sweep data collection rate (Hz) | 0.5 |
| Serial data collection rate (Hz) | 100 |

Information per unit damage as a function of electron energy and crystal thickness:

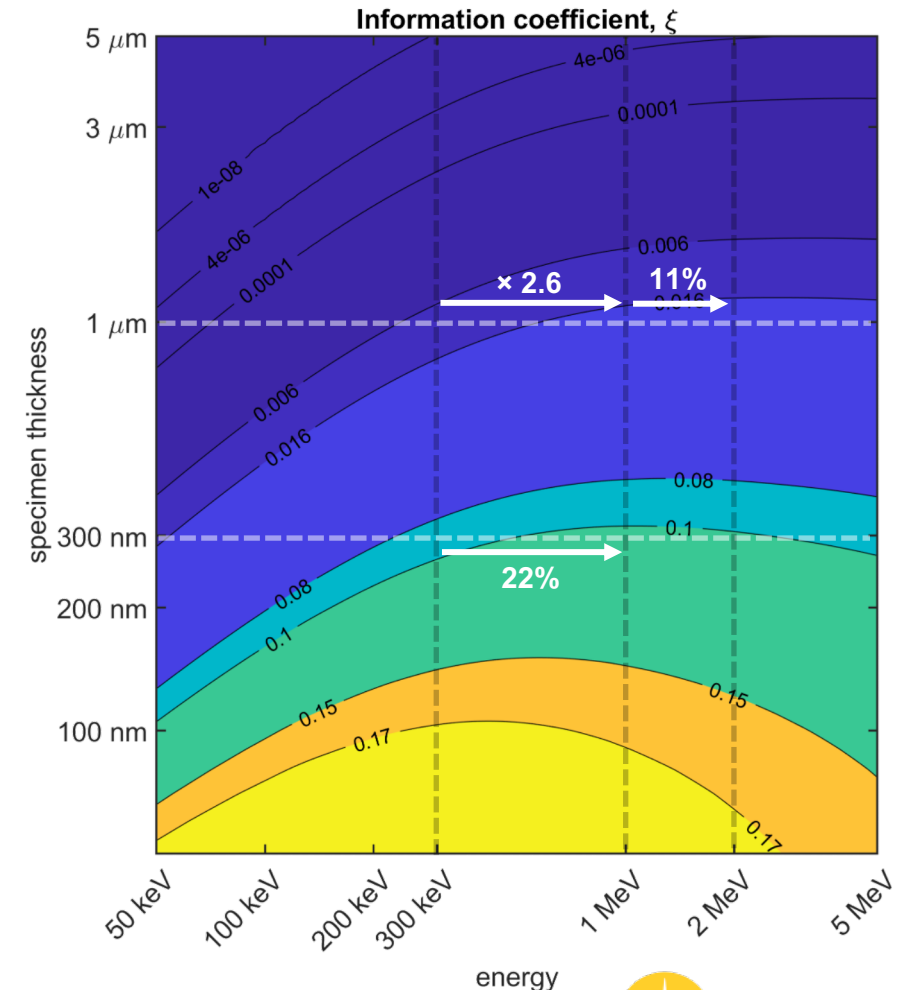
Information coefficient:

$$\zeta \equiv T \frac{\sigma_e}{\sigma_i}$$

σ_e ← Elastic cross-section
 σ_i ← Inelastic cross-section
 $T \simeq e^{-t/\lambda}$ ← Total mean free path
 t ← Specimen thickness

M. J. Peet, R. Henderson, C. J. Russo, Ultramicroscopy 203 (2019)

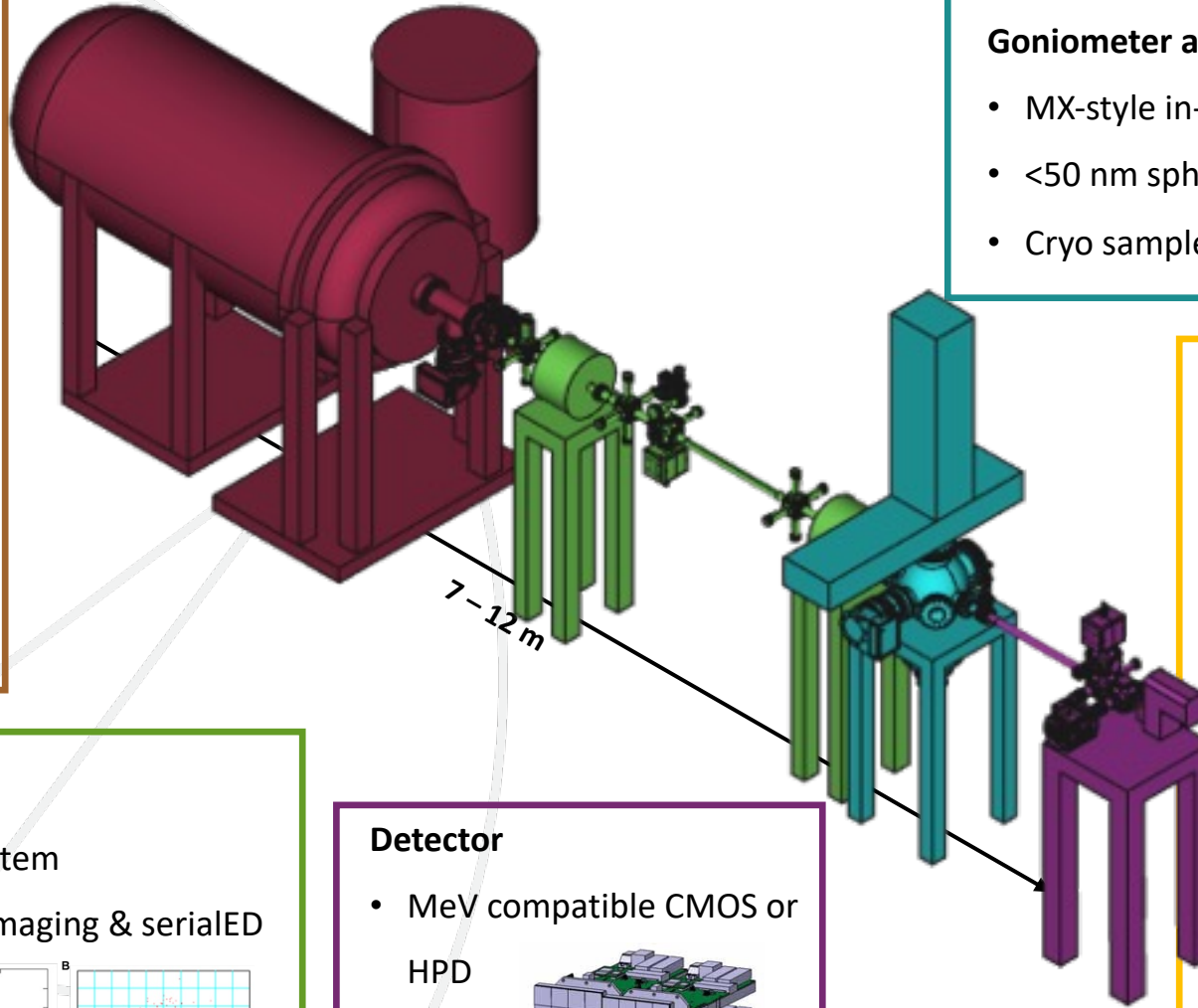
- Continuously tunable
- High flux
- Match crystal size
- 10 x faster than TEM
- Cryo-capabilities



HeXI instrument design concept

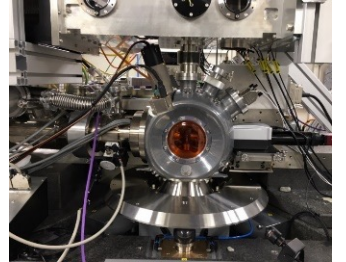
1 MeV electron source

- Cockcroft-Walton generator
- Electrostatic accelerator
- LaB₆ emitter
- Continuously tunable



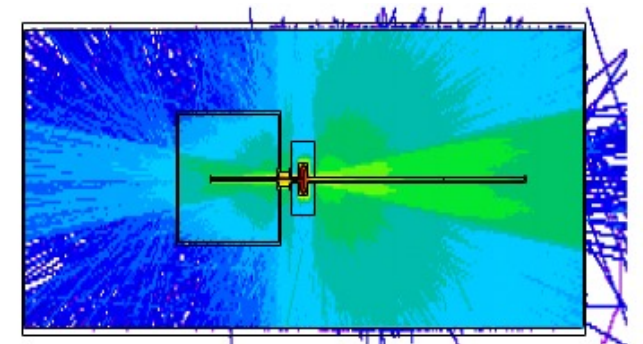
Goniometer and sample environment

- MX-style in-vacuum goniometer
- <50 nm sphere of confusion
- Cryo sample exchanger and hotel



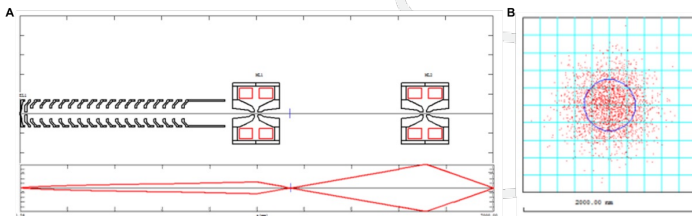
Shielding & Location

- ~820 mm concrete or ~160 mm lead (assuming 15 μ A 1 MeV beam)
- B10 wedge on Experimental Hall floor
- Typical “optics hutch” - 50mm lead construction



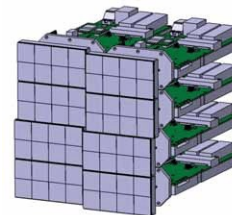
Electron optics

- Bespoke 2 or 3-condenser system
- Scanning capabilities: STEM imaging & serialED

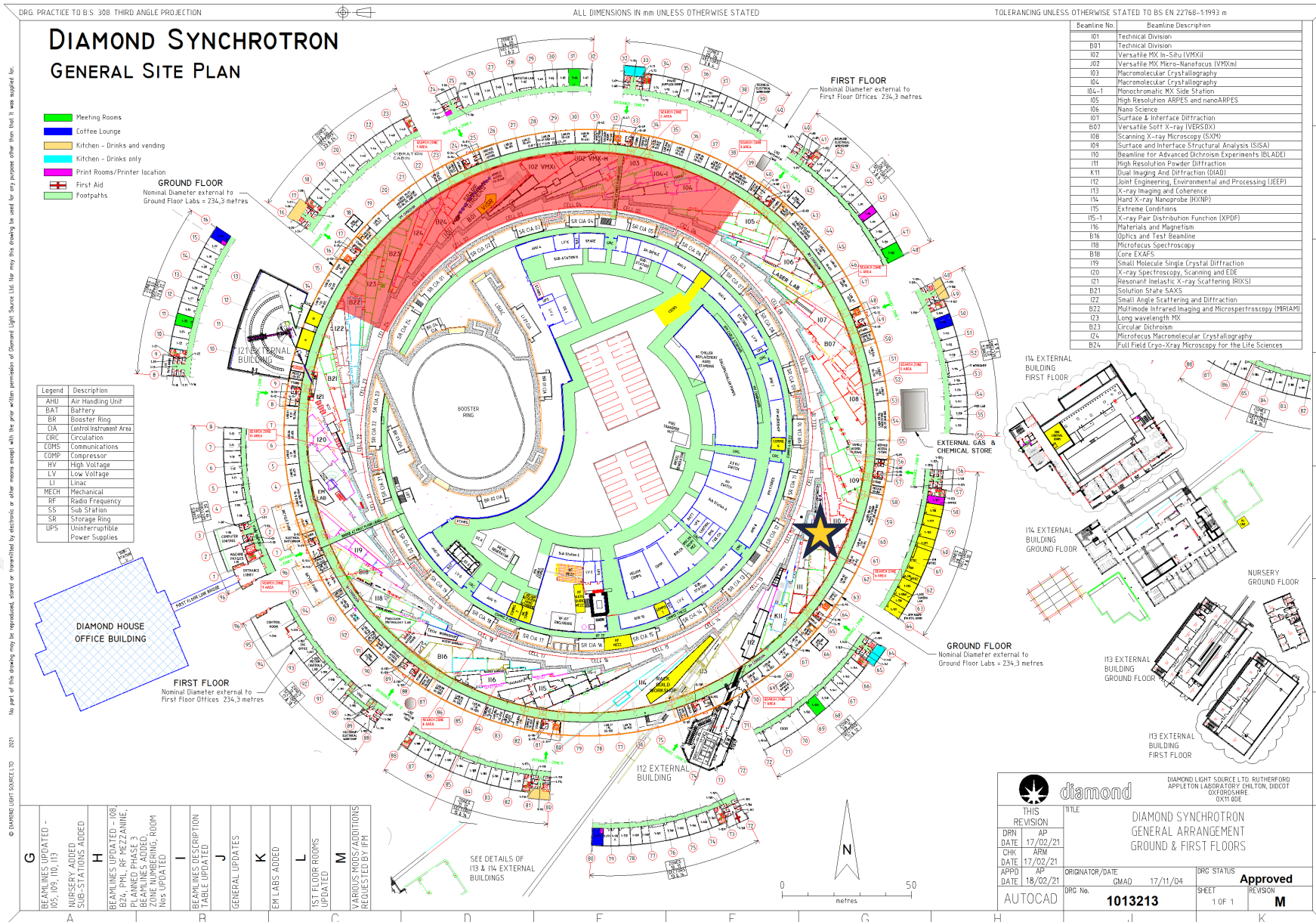


Detector

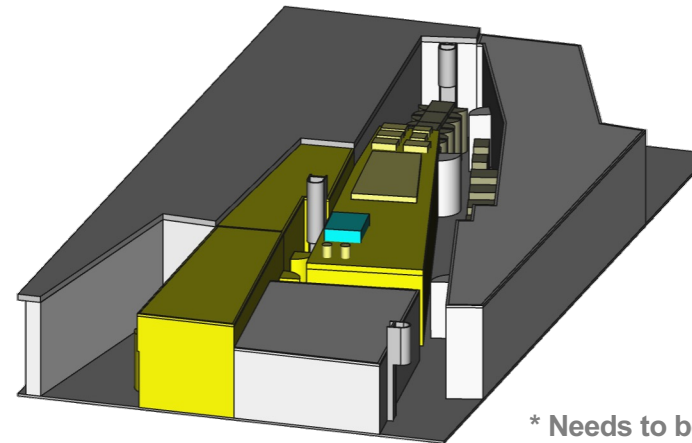
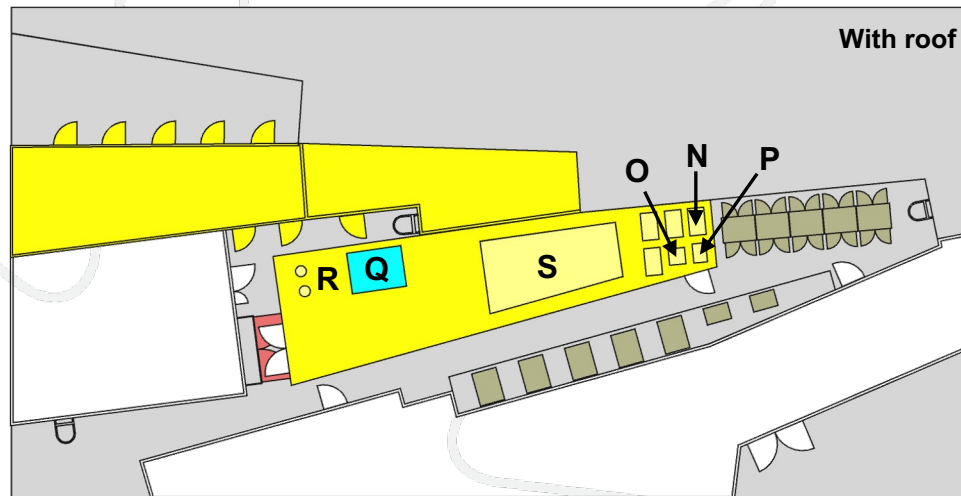
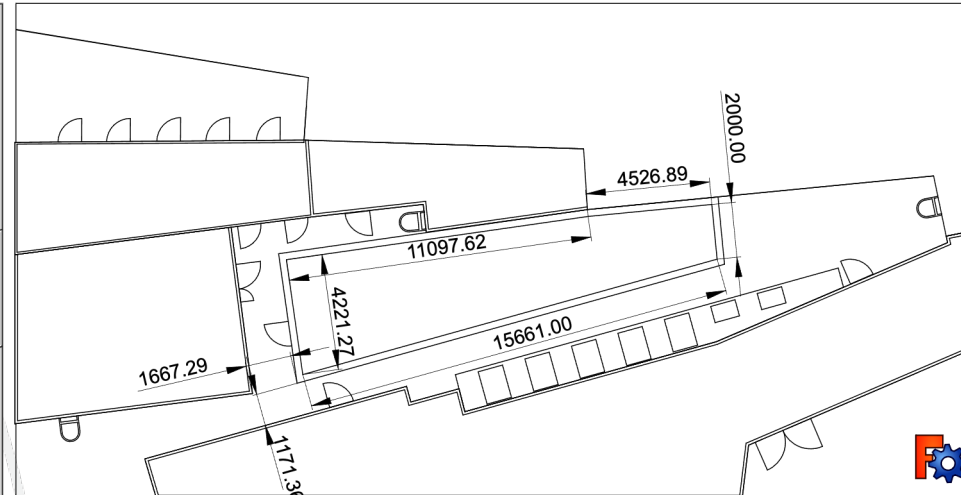
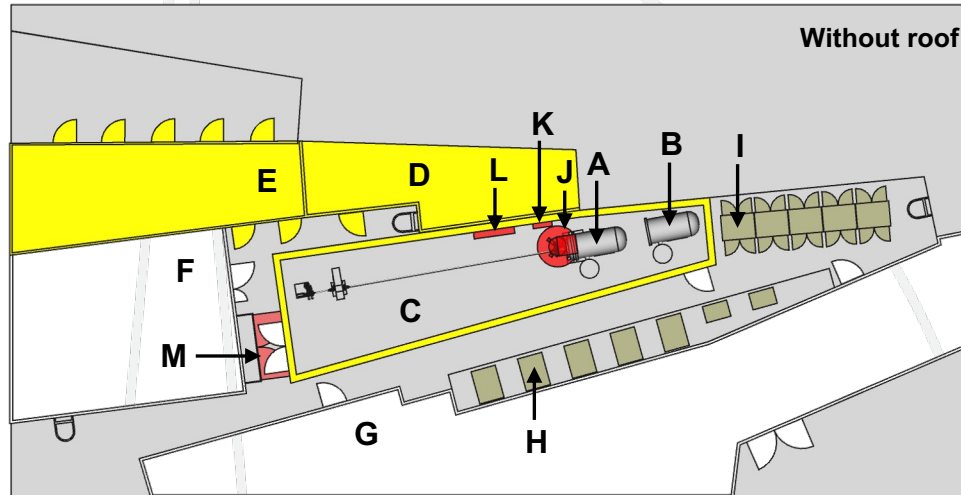
- MeV compatible CMOS or HPD



HeXI location



HeXI hutch design concept



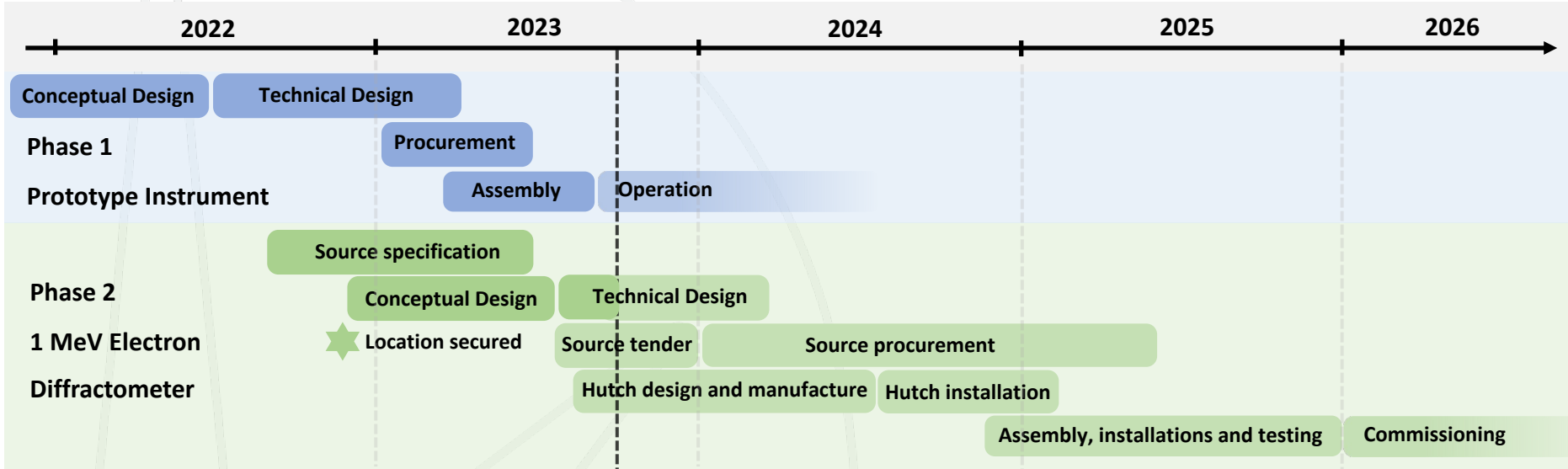
* Needs to be modified

- A – HeXI instrument
- B – HeXI service position
- C – HeXI hutch
- D – I11 OH1
- E – I11 CIA
- F – I11 CC2
- G – I10 Cabin
- H – I10 racks
- I – HeXI racks
- J – I11 cryo-cooler*
- K – I11 chicanes*
- L – I11 radiation monitor*
- M – I11 cylinder cage*
- N – HeXI electronics chicanes
- O – HeXI services chicanes
- P – HeXI LN2 chicanes
- Q – HeXI air handling
- R – HeXI in/out vents
- S – HeXI removable roof

- Completed the preliminary room datasheet and specification for the HeXI hutch
- Started the design brief documentation for hutch tender

Project milestones

Project plan:



Recent and upcoming milestones:

- Conceptual design report submitted and signed-off – August 2023
- Functional specification completed and signed-off – September 2023
- Technical design report on track for submission by December 2023
- Technical design report sign-off scheduled for March 2024

HeXI Phase 1 Prototype Instrument



- Test optical configurations
- Investigate crystal targeting
- Prototype diagnostic tools
- De-risk phase 2 instrument

Project outlook

1. Deliver an instrument ready for commissioning in 2026

- Unique addition to Diamond's suite of crystallography instruments

2. Perform systematic multi-modal structural determination studies

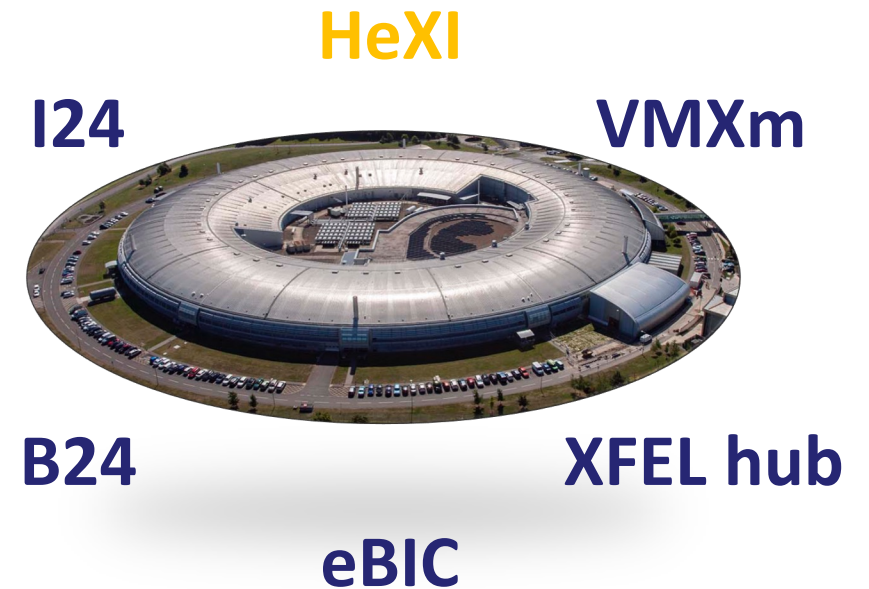
- Synergy between HeXI and VMXm
- Leverage the inherent complementarity of electrons and X-rays

3. Perform time-resolved serialED on slurries of sub-micron sized crystals

- Future synergies with XFEL hub and I24

4. Explore micron-scale MeV electron imaging

- Future synergies with eBIC and B24



Acknowledgments



HeXI Team

Pedro Nunes

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(DIALS/RFI)



Diamond VMXm

Adam Crawshaw

Anna Warren



Diamond eBIC

David Owen

Dan Clare



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Jim Naismith

STRUBI

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eBIC

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